1.6X0.8X0.8 (mm) WiFi/Bluetooth Ceramic Chip Antenna

(YF1608-1) Engineering Specification

1. Product Number

YF 1608 F2 P 2G45 02 1 2 3 4 5 6



2. Features

(1)Product Type	Chip Antenna
(2)Size Code	1.6x0.8x0.8mm
(3)Type Code	F2
(4)Packing	Plastic Packaging
(5)Frequency	2.45GHz

^{*}Stable and reliable in performances

^{*}SMT processes compatible



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Prepared by : JIEXI Designed by : Jason Checked by : Jason Approved by : MR.FANG

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^{*}Low temperature coefficient of frequency

^{*}Low profile, compact size

^{*}RoHS compliance

3. Applications

- *Bluetooth earphone systems
- *Hand-held devices when WiFi /Bluetooth functions are needed, e.g., Smart phone.
- *IEEE802.11 b/g/n
- *ZigBee
- *Wireless PCMCIA cards or USB dongle

4. Description

Yingfeng chip antenna series are specially designed for WiFi/Bluetooth applications. Based on yingfeng proprietary design and processes, this chip antenna has excellent stability and sensitivity to consistently provide high signal reception efficiency.

5. Electrical Specifications (50 x 40 mm² ground plane)

5-1. Electrical Table

	Characteristics	Specifications	Unit
Outline Dimensions		1.6x0.8x0.8	mm
Working Frequency		2400~2500	MHz
VSWR		2 Max.	
Impedance		50	Ω
Polarization		Linear Polarization	
Peak		2.5 (typical)	dBi
Gain		75 (typical)	%



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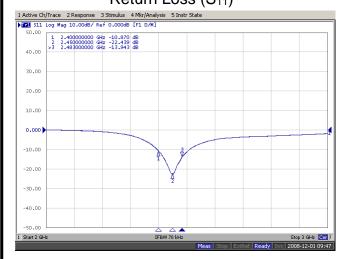
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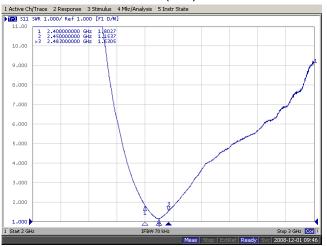
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5-2. Return Loss & VSWR Return Loss (S₁₁)



VSWR(S₁₁)



Antenna Dimensions & Test Board (unit: mm) 6.

a. Antenna Dimensions

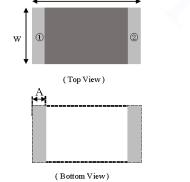
Applications

1. Bluetooth

TITLE: 1.6x 0.8 x0.8(mm) WiFi/Bluetooth Ceramic Chip

- 2. Wireless LAN
- 3. ISM band 2.4GHz wireless applications

Dimensions (Unit: mm)



	↓ .	Т	
(Side View)			
T		A	

Terminal Name INPUT

Symbols L Dimensions 1.60 ± 0.20		W	Т	A	
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.80 ± 0.20	0.30 ± 0.10	

Unit: mm



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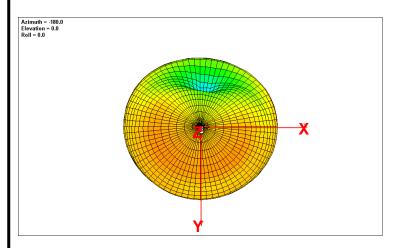
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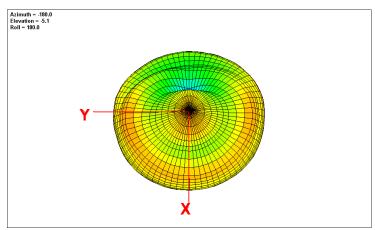
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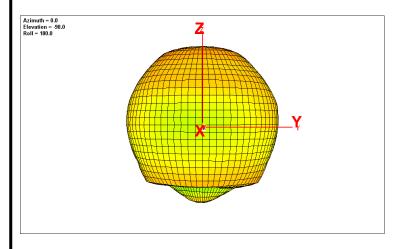
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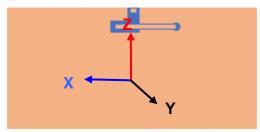
7. Radiation Pattern (50 x 40 mm² ground plane)

7-1. 3D Gain Pattern @ 2442 MHz









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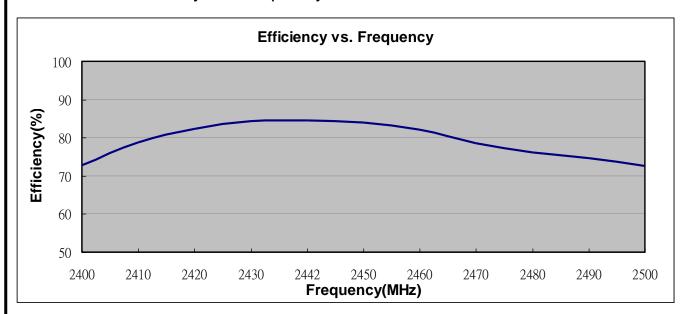
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7-2. 3D Efficiency Table

Frequency(MHz)	2400	2410	2420	2430	2442	2450	2460	2470	2480	2490	2500
Efficiency (dB)	-1.4	-1.0	-0.9	-0.7	-0.7	-0.8	-0.9	-1.1	-1.2	-1.3	-1.4
Efficiency (%)	72.8	73.7	74.3	74.4	75.5	75.0	74.0	73.6	73.1	72.6	71.5
Gain (dBi)	2.1	2.2	2.3	2.4	2.5	2.5	2.4	1.8	1.7	1.6	1.4

7-3. 3D Efficiency vs. Frequency



8. **Layout Guide**

a. Solder Land Pattern:

Land pattern for soldering (gray marking areas) is as shown below. Depending on Customer's requirement, matching circuit as shown below is also recommended.



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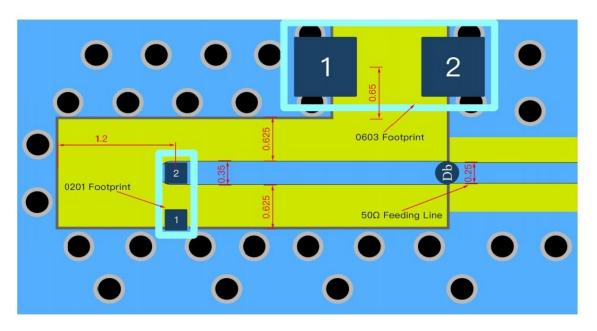
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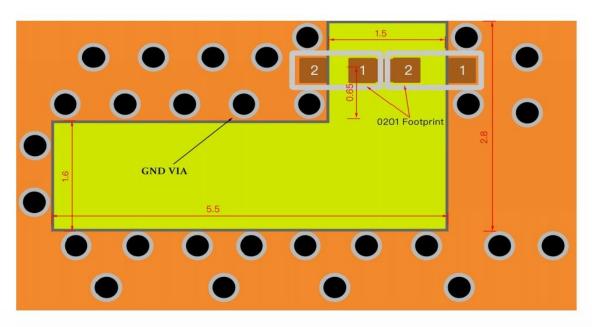
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Evaluation Board and Matching Circuits







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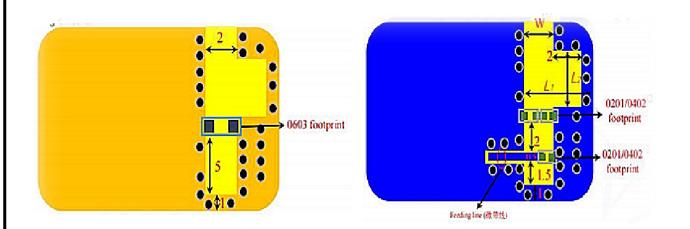
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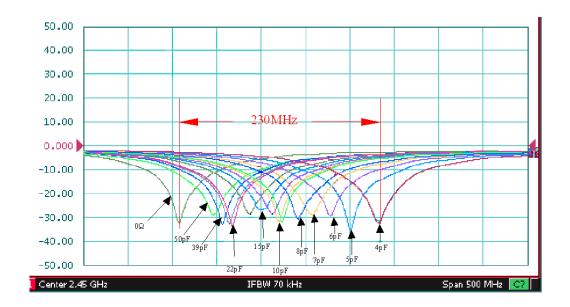
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Bottom View

Unit: mm

c. Fine tuning element vs. Center frequency





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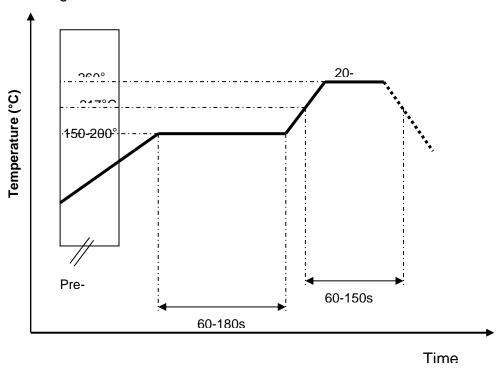
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9. Soldering Conditions

a. Typical Soldering Profile for Lead-free Process



Packing

(1) Quantity/Reel: 4000 pcs/Reel

(2) Plastic tape:



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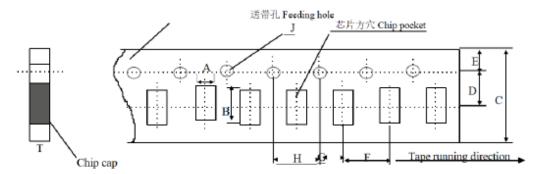
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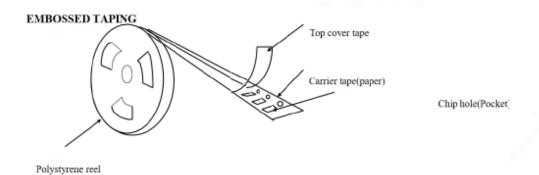
Dimensions of paper taping



Unit: mm

代号Code 纸带规格 papersize	A	В	С	D*	E	F	G*	Н	1	Т
尺寸	1.10	1.90	8.00	3.50	1.75	4.00	2.00	4.00	1.50	1.10
	±0.10	±0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.10	-0/+0.10	Max

Reel (4000 pcs/Reel)



Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition). Temperature: $5\sim40^{\circ}$ C/Relative Humidity: $20\sim70\%$



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